

OptiMOS®-T2 Power-Transistor





Features

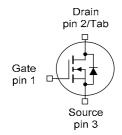
- N-channel Enhancement mode
- Automotive AEC Q101 qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- 100% Avalanche tested
- Ultra low R_{DSon}

Product Summary

V _{DS}	60	V
R _{DS(on),max}	6.3	mΩ
I _D	90	Α

PG-TO252-3-11





Type Package Marking IPD90N06S4L-06 PG-TO252-3-11 4N06L06

Maximum ratings, at T_j =25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I _D	T _C =25°C, V _{GS} =10V	90	Α
		$T_{\rm C}$ =100°C, $V_{\rm GS}$ =10 $V^{2)}$	63	
Pulsed drain current ¹⁾	I _{D,pulse}	T _C =25°C	360	
Avalanche energy, single pulse ¹⁾	E _{AS}	I _D =45A	67	mJ
Avalanche current, single pulse	IAS	-	90	А
Gate source voltage	V_{GS}	-	±16	V
Power dissipation	P _{tot}	T _C =25°C	79	W
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-	-55 +175	°C
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	_



Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal characteristics ¹⁾						
Thermal resistance, junction - case	R_{thJC}	-	-	-	1.9	K/W
SMD version, device on PCB	R_{thJA}	minimal footprint	-	-	62	
		6 cm ² cooling area ²⁾	-	-	40	

Electrical characteristics, at T_j =25 °C, unless otherwise specified

Static characteristics

Drain-source breakdown voltage	V _{(BR)DSS}	$V_{\rm GS}$ =0V, $I_{\rm D}$ = 1mA	60	-	-	V
Gate threshold voltage	$V_{\rm GS(th)}$	$V_{\rm DS}=V_{\rm GS}, I_{\rm D}=40\mu{\rm A}$	1.2	1.7	2.2	
Zero gate voltage drain current	I _{DSS}	$V_{\rm DS}$ =60V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =25°C	-	0.01	1	μΑ
		$V_{\rm DS}$ =60V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =125°C ²⁾	-	5	100	
Gate-source leakage current	I _{GSS}	V _{GS} =16V, V _{DS} =0V	-	-	100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =4.5V, I _D =45A	-	7.4	11.0	mΩ
		V _{GS} =10V, I _D =90A	-	5.0	6.3	



Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	
Dynamic characteristics ¹⁾						
Input capacitance	C iss		-	4370	5680	pF
Output capacitance	C oss	V _{GS} =0V, V _{DS} =25V, f=1MHz	-	980	1270	
Reverse transfer capacitance	C _{rss}		-	45	90	
Turn-on delay time	t _{d(on)}		-	10	-	ns
Rise time	t _r	V _{DD} =30V, V _{GS} =10V,	-	3	-	
Turn-off delay time	$t_{\text{d(off)}}$	$I_{\rm D}$ =90A, $R_{\rm G}$ =3.5 Ω	-	50	-	
Fall time	t _f		-	8	-	
Gate Charge Characteristics ¹⁾						
Gate to source charge	Q _{gs}		-	17	22	nC
Gate to drain charge	Q_{gd}	$V_{\rm DD}$ =48V, $I_{\rm D}$ =90A, $V_{\rm GS}$ =0 to 10V	-	6	12	
Gate charge total	Q _g		-	58	75	
Gate plateau voltage	$V_{\rm plateau}$		-	4.0	-	V
Reverse Diode						
Diode continous forward current ¹⁾	Is		-	-	90	А
Diode pulse current ¹⁾	I _{S,pulse}		-	-	360	
Diode forward voltage	V _{SD}	V _{GS} =0V, I _F =90A, T _j =25°C	0.6	0.95	1.3	V
Reverse recovery time ¹⁾	t _{rr}	V_{R} =30V, I_{F} =90A, di_{F}/dt =100A/ μ s	-	39	-	ns
Reverse recovery charge ¹⁾	Q _{rr}		-	38	-	nC

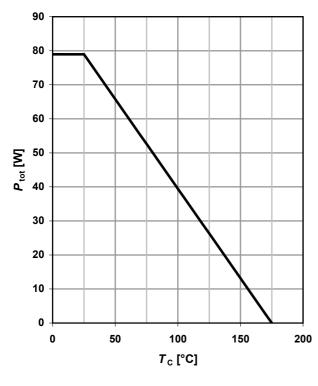
¹⁾ Specified by design. Not subject to production test.

 $^{^{2)}}$ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.



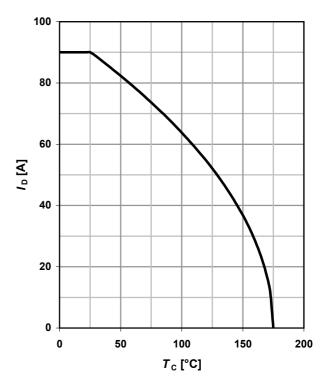
1 Power dissipation

$$P_{\text{tot}} = f(T_{\text{C}}); V_{\text{GS}} \ge 6 \text{ V}$$



2 Drain current

$$I_D = f(T_C); V_{GS} \ge 6 \text{ V}$$



3 Safe operating area

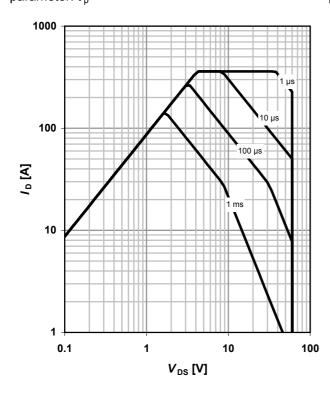
$$I_D = f(V_{DS}); T_C = 25 \,^{\circ}C; D = 0$$

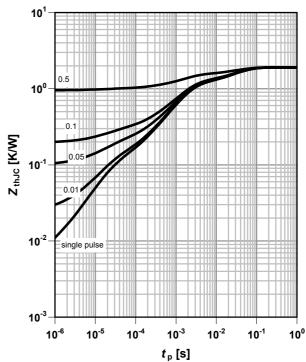
parameter: t_p

4 Max. transient thermal impedance

$$Z_{\rm thJC} = f(t_{\rm p})$$

parameter: $D = t_p/T$



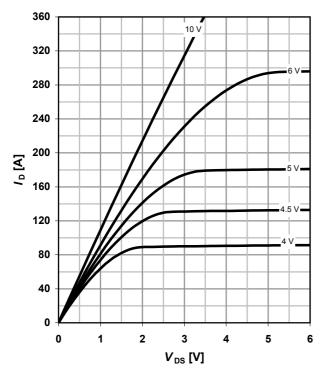




5 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 25 °C$

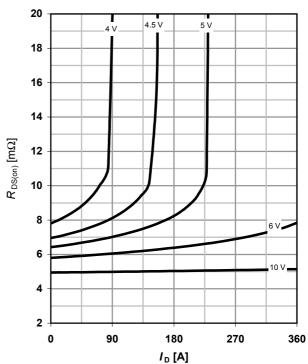
parameter: $V_{\rm GS}$



6 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(I_D); T_j = 25 °C$

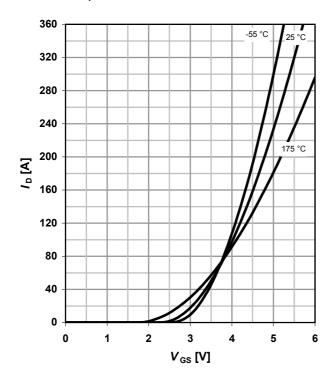
parameter: V_{GS}



7 Typ. transfer characteristics

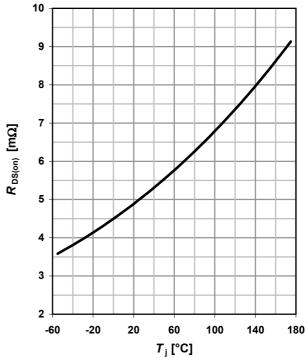
 $I_D = f(V_{GS}); V_{DS} = 6V$

parameter: T_i



8 Typ. drain-source on-state resistance

$$R_{DS(on)} = f(T_j); I_D = 90 \text{ A}; V_{GS} = 10 \text{ V}$$





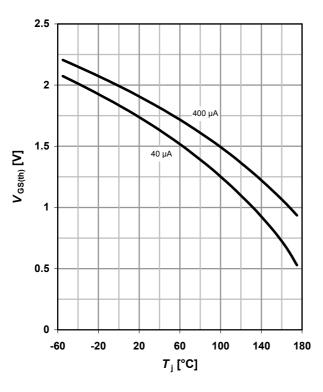
9 Typ. gate threshold voltage

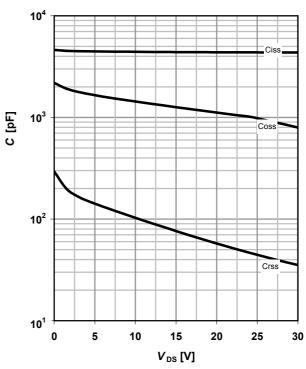
 $V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$

parameter: I_D

10 Typ. capacitances

 $C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$





11 Typical forward diode characteristicis

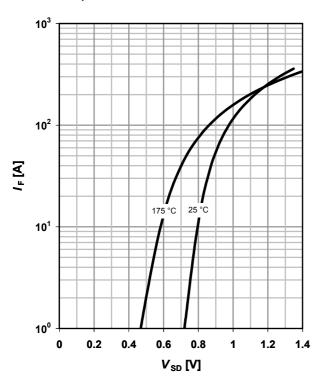
 $IF = f(V_{SD})$

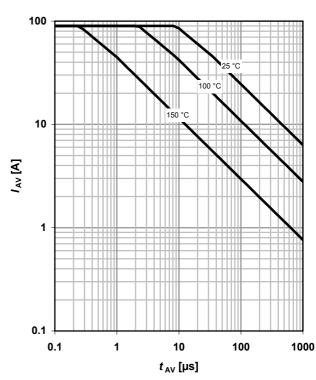
parameter: T_i

12 Avalanche characteristics

 $I_{AS} = f(t_{AV})$

parameter: $T_{j(start)}$





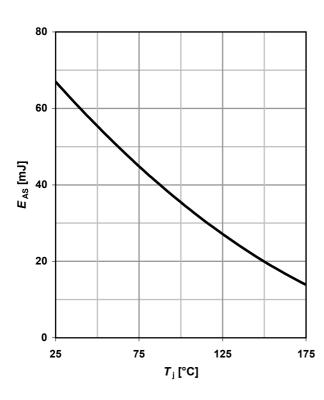


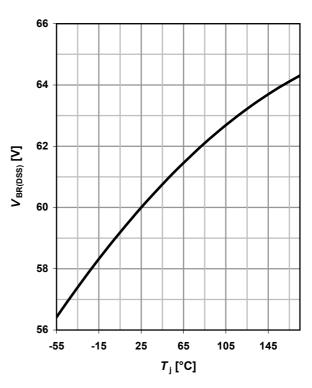
13 Avalanche energy

$$E_{AS} = f(T_i); I_D = 45 A$$

14 Drain-source breakdown voltage

$$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$$

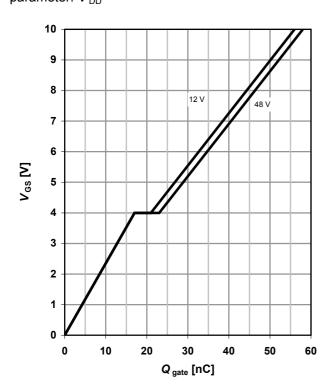




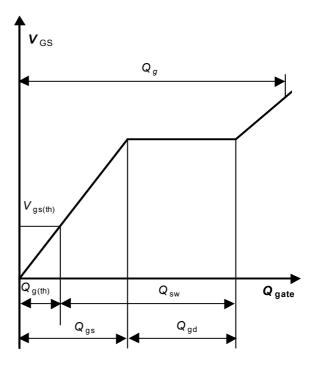
15 Typ. gate charge

 $V_{\rm GS}$ = f(Q $_{\rm gate}$); $I_{\rm D}$ = 90 A pulsed

parameter: $V_{\rm DD}$



16 Gate charge waveforms





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Revision History

Version	Date	Changes		
Revision 1.0	24.03.2009	Final data sheet		